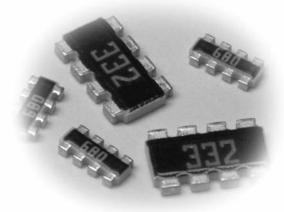




convex termination with scalloped corners resistor array

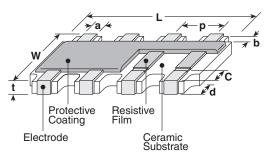


features



- Manufactured to type RK73 standards
- Less board space than individual chips
- Isolated resistor elements
- Convex terminations with scalloped corners
- Marking: Marked with resistance value
- Products with lead-free terminations meet RoHS requirements. Pb located in glass material, electrode and resistor element is exempt per Annex 1, exemption 5 of EU directive 2005/95/EC

dimensions and construction



Size	Dimensions inches (mm)							
Code	L	W	C	d	t	а	b	p (ref.)
1J4A		.063±.006 (1.6±0.15)						.031 (0.8)
2B4A	0.2±.008 (5.1±0.2)	.122±.008 (3.1±0.2)	.020±.008 (0.5±0.2)					.050 (1.27)

ordering information













(Other termination for options)

Packaging TE: 7" embossed plastic

TD

TD: 7" paper tape TED: 10" embossed plastic TDD: 10" paper tape

101			
Nominal Resistance			

2 significant figures + 1 multiplier for ±2% & ±5% 3 significant figures + 1 multiplier for ±1%



For further information on packaging, please refer to Appendix A.





convex termination with scalloped corners resistor array

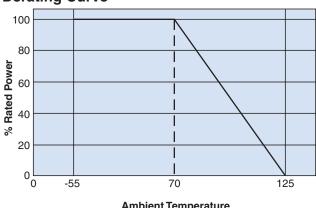
circuit schematic

applications and ratings

Part Designation	Power Rating @ 70°C (Per Element)	T.C.R. (ppm/°C) Max.	Resistance Range E-96 (F±1%)	Resistance Range E-24 (J±5%)	Absolute Maximum Working Voltage	Absolute Maximum Overload Voltage	Operating Temperature Range
CN1J4A	1/16W (.063W)	±200:≥10Ω	10 - 100kΩ	1Ω - 1ΜΩ	50V	100V	-55°C to +125°C
CN2B4A	1/8W (.125W)	±400:R<10Ω		10Ω - 1ΜΩ	200V	400V	-55 0 10 +125 0

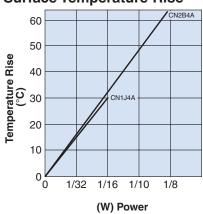
environmental applications

Derating Curve



Ambient Temperature (°C)

Surface Temperature Rise



Performance Characteristics

Parameter	Maximum ∆ R	Test Method			
Thermal Shock		MIL-STD-202, Method 107, -55°C to +125°C, 5 cycles			
Low Temperature Operation	$\pm (1.0\% + 0.1\Omega)$	MIL-R-55342 π 4.7.4, 1 hour @ -55°C followed by 45 minutes of RCWV*			
High Temperature Exposure		MIL-R-55342 π 4.7.6, 100 hours @ 125°C			
Short Time Overload	$\pm (2.0\% + 0.05\Omega)$	MIL-R-55342 π 4.7.5, 2.5 x RCWV for 5 seconds			
Resistance to Solder Heat	. (1.00/ . 0.10)	MIL-R-55342 π 4.7.7, 260°C for 10 seconds			
Terminal Strength-Push	$\pm (1.0\% + 0.1\Omega)$	1.2 Kg for 1 minute			
Terminal Strength-Bend	$\pm (0.5\% + 0.05\Omega)$	5mm deflection in either direction for 10 seconds			
Moisture Resistance		MIL-STD-202, Method 103, 40°C, 90 - 95% RH, 1000 hours			
Life	±5.0%	MIL-STD-202, Method 108, 70°C, 1000 hours @ RCWV, 1.5 hr ON, 0.5 hr OFF			
Pulse		2.5 x RCWV, not exceeding max. overload voltage, 1 sec. ON, 25 sec. OFF, 10,000 cycles			
Temperature Cycling	±1.0%	30 min. @ -55°C, 15 min. @ +25°C, 30 min. @ +125°C, 15 min. @ +25°C, 5 cycles			
Terminal Adhesion	15 Grams Minimum	Axial pull, one terminal at a time			
Dielectric Withstanding Voltage					
CN1J4A	100V	1 minute minimum			
CN2B4A	400V	MIL-STD-202, Method 301			
Insulation Resistance	1,000 MΩ Minimum	_			

^{*} RCWV = Rated Continuous Working Voltage.